



## CP1101SB Series

Rev.1.0

### DESCRIPTION:

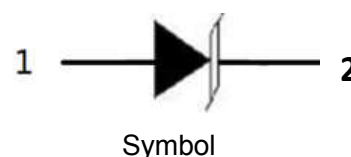
CP1101SB series thyristors is a type of semi-conduct component. They are designed to protect baseband equipment from damaging overvoltage transients. such as modems, telephones, line cards, answering machines, FAX machines, T1/E1, xDSL and more.



SMB

### FEATURES:

- ✧ Excellent capability of absorbing transient surge
- ✧ Quick response to surge voltage (ns Level)
- ✧ Eliminates overvoltage caused by fast rising transients
- ✧ Moisture sensitivity level: Level 1
- ✧ Non degenerative

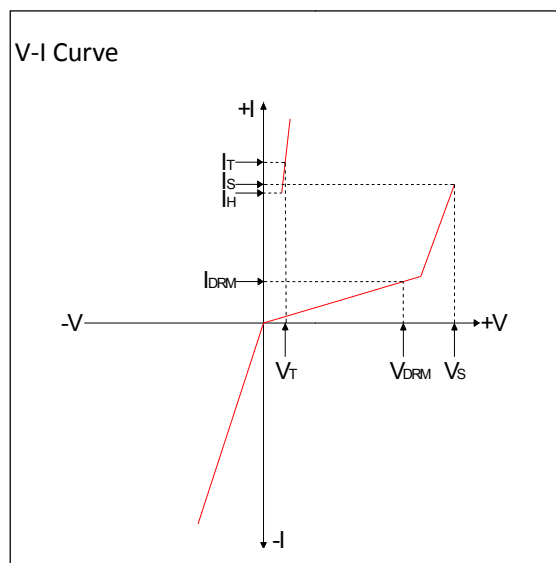


### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^{\circ}\text{C}$ , RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	$T_{stg}$	-60 to +150	$^{\circ}\text{C}$
Operating junction temperature range	$T_j$	-40 to +150	$^{\circ}\text{C}$
Repetitive peak pulse current	$I_{PP}$	80	A

### ELECTRICAL CHARACTERISTICS ( $T_A=25^{\circ}\text{C}$ )

Symbol	Parameter
$V_{DRM}$	Peak off-state voltage
$I_{DRM}$	Off-state current
$V_S$	Switching voltage
$I_S$	Switching current
$V_T$	On-state voltage
$I_T$	On-state current
$I_H$	Holding current
$C_O$	Off-state capacitance



**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub>=25°C, continued)

Part Number	I <sub>DRM</sub> @V <sub>DRM</sub>		V <sub>S</sub> <sup>①</sup> @I <sub>S</sub>		V <sub>T</sub> @ I <sub>T</sub>		I <sub>H</sub>	C <sub>O</sub> <sup>②</sup>	Marking
	μA	V	V	mA	V	A	mA	pF	
	max		max	max	max	max	min	max	
CP1101SB	5	95	130	800	4	2.2	100	70	A11B
CP1301SB	5	115	140	800	4	2.2	100	70	A13B

① V<sub>S</sub> is measured at 100KV/s

② Off-state capacitance is measured in V<sub>DC</sub>=2V, V<sub>RMS</sub>=1V, f=1MHz

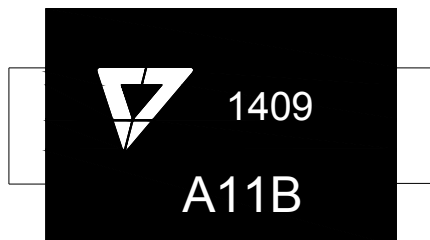
**SURGE RATINGS**

Series	I <sub>PP</sub> (A) min			
	2×10us	8×20us	10×360us	10×1000us
B	250	250	125	80

**ORDERING INFORMATION**

<p><b>CP</b> Series code P: SIDACTor</p>	<p><b>110</b> Median voltage</p>	<p><b>1</b> 0: Bi-direction 1: Uni-direction</p>	<p><b>S</b> Surge ratings:4KV(10/700us) Package type:SMB</p>	<p><b>B</b></p>
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**MARKING**



A11B : Device Marking Code  
1409: In ninth week, 2014

SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see FIG.2)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ ) (Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_P$ )		8 min. Max
Do not exceed		+260°C

FIG.1: tr × td pulse waveform

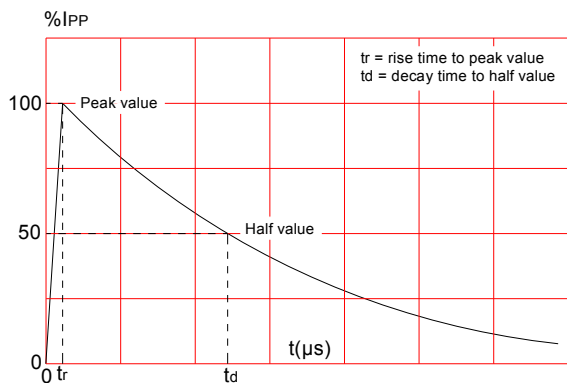


FIG.3: Normalized Vs change vs. junction temperature

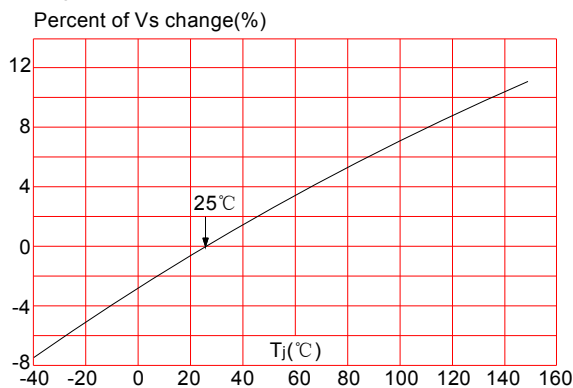


FIG.2: Reflow condition

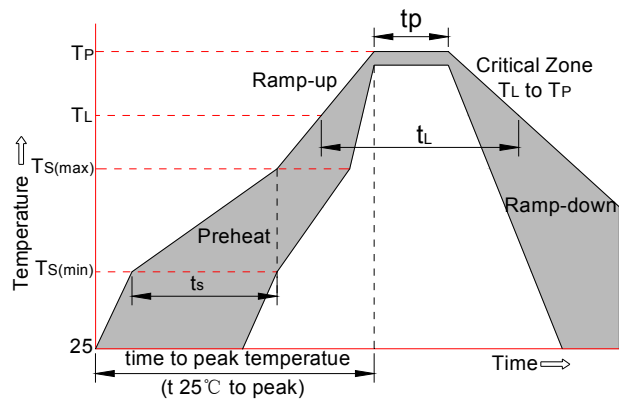
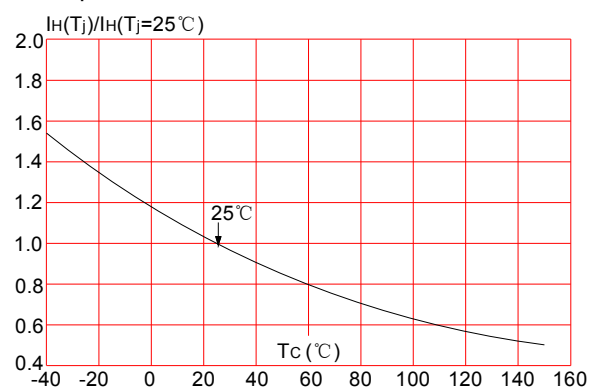
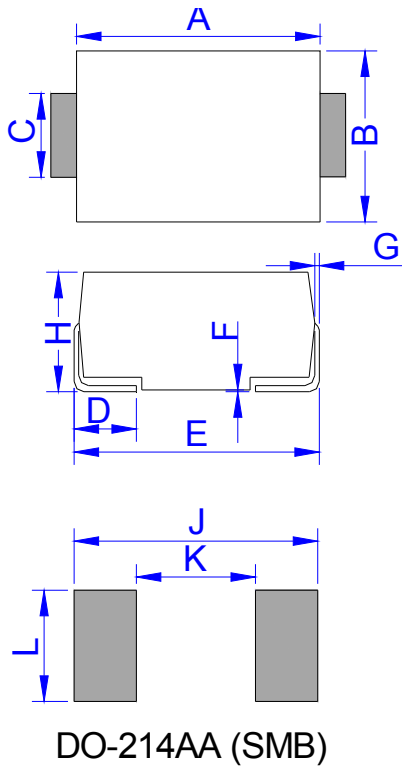


FIG.4: Normalized DC holding current vs. case temperature

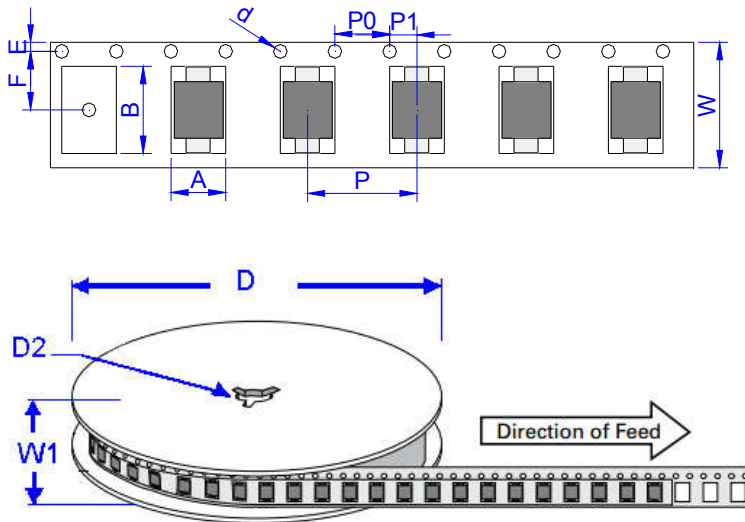


PACKAGE MECHANICAL DATA



Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.25	4.75	0.167	0.187
B	3.30	3.94	0.130	0.155
C	1.85	2.21	0.073	0.087
D	0.76	1.52	0.030	0.060
E	5.08	5.59	0.200	0.220
F	0.051	0.203	0.002	0.008
G	0.15	0.31	0.006	0.012
H	2.11	2.44	0.083	0.096
J	6.80		0.270	
K		2.60		0.100
L	2.40		0.090	

TAPE AND REEL SPECIFICATION-SMB



Ref.	Dimensions	
	Millimeters	Inches
A	3.76 ± 0.2	0.144 ± 0.012
B	5.69 ± 0.2	0.244 ± 0.012
d	1.5 ± 0.25	0.059 ± 0.004
D	330.0	13.0
D2	13 ± 1	0.512 ± 0.039
E	1.75 ± 0.2	0.059 ± 0.008
F	5.5 ± 0.1	0.222 ± 0.008
P	8.0 ± 0.2	0.315 ± 0.008
P0	4.0 ± 0.2	0.157 ± 0.008
P1	2.0 ± 0.2	0.079 ± 0.008
W	12.0 ± 0.3	0.472 ± 0.008
W1	16.8 ± 2.0	0.661 ± 0.079

OUTLINE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)
TAPING	3,000	48,000	330

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